

2SA1124

Silicon PNP epitaxial planar type

For low-frequency high breakdown voltage amplification
Complementary to 2SC2632

■ Features

- Satisfactory forward current transfer ratio h_{FE} collector current I_C characteristics.
- High collector-emitter voltage (Base open) V_{CEO}
- Small collector output capacitance (Common base, input open circuited) C_{ob}
- Makes up a complementary pair with 2SC2632, which is optimum for the pre-driver stage of a 40 W to 60 W output amplifier.

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|-----------|-------------|------------------|
| Collector-base voltage (Emitter open) | V_{CBO} | -150 | V |
| Collector-emitter voltage (Base open) | V_{CEO} | -150 | V |
| Emitter-base voltage (Collector open) | V_{EBO} | -5 | V |
| Collector current | I_C | -50 | mA |
| Peak collector current | I_{CP} | -100 | mA |
| Collector power dissipation | P_C | 1 | W |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

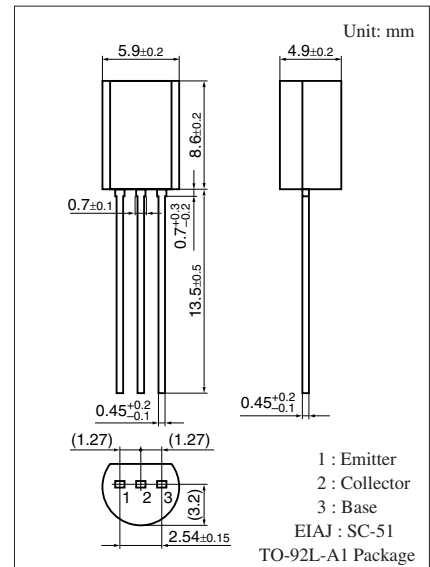
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

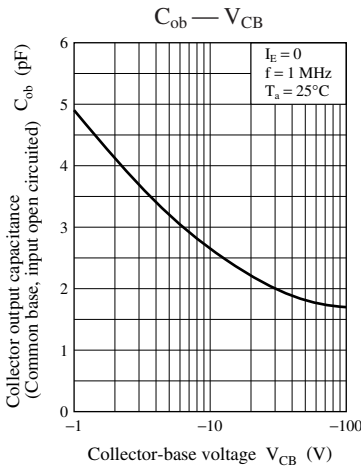
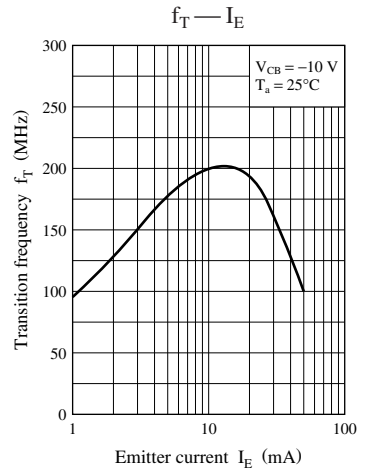
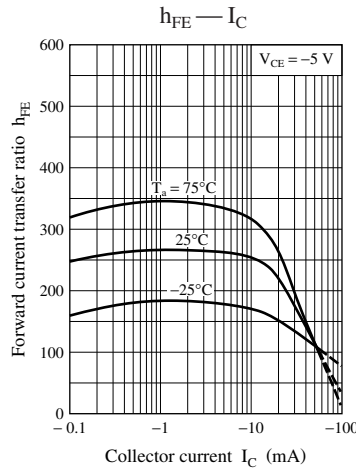
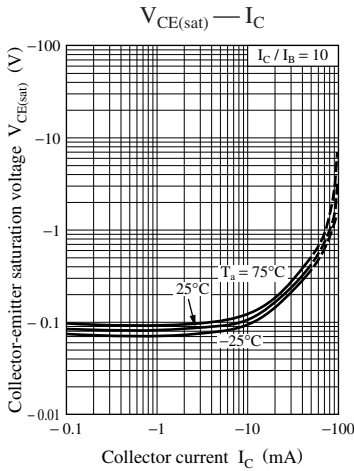
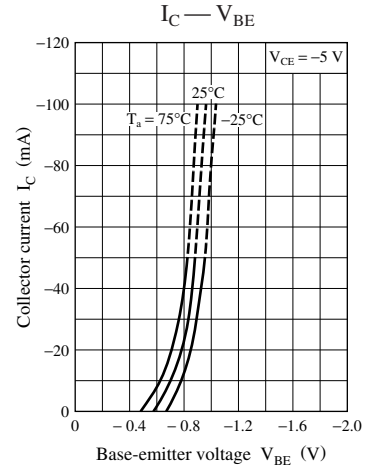
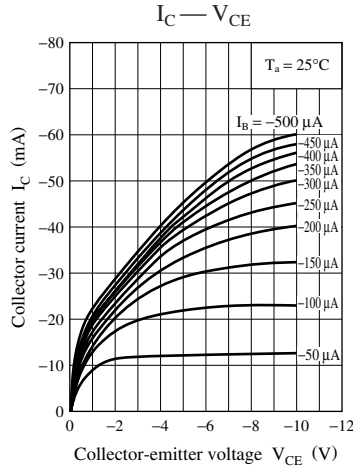
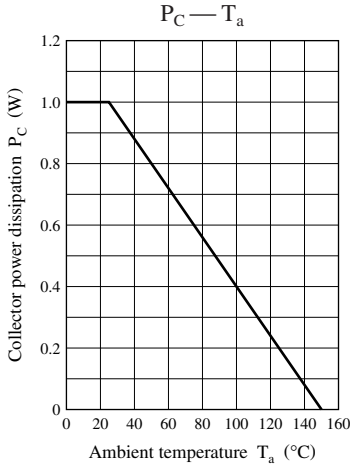
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|---|---------------|--|------|-----|-----|---------------|
| Collector-emitter voltage (Base open) | V_{CEO} | $I_C = -0.1 \text{ mA}, I_B = 0$ | -150 | | | V |
| Emitter-base voltage (Collector open) | V_{EBO} | $I_E = -10 \mu\text{A}, I_C = 0$ | -5 | | | V |
| Collector-base cutoff current (Emitter open) | I_{CBO} | $V_{CB} = -100 \text{ V}, I_E = 0$ | | | -1 | μA |
| Forward current transfer ratio * | h_{FE} | $V_{CE} = -5 \text{ V}, I_C = -2 \text{ mA}$ | 130 | | 330 | — |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $I_C = -30 \text{ mA}, I_B = -3 \text{ mA}$ | | | -1 | V |
| Transition frequency | f_T | $V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$ | | 200 | | MHz |
| Collector output capacitance (Common base, input open circuited) | C_{ob} | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | | 5 | pF |
| Noise voltage | NV | $V_{CE} = -10 \text{ V}, I_C = -1 \text{ mA}, G_V = 80 \text{ dB}$ $R_g = 100 \text{ k}\Omega, \text{Function} = \text{FLAT}$ | | 150 | 300 | mV |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

| Rank | R | S |
|----------|------------|------------|
| h_{FE} | 130 to 220 | 185 to 330 |





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